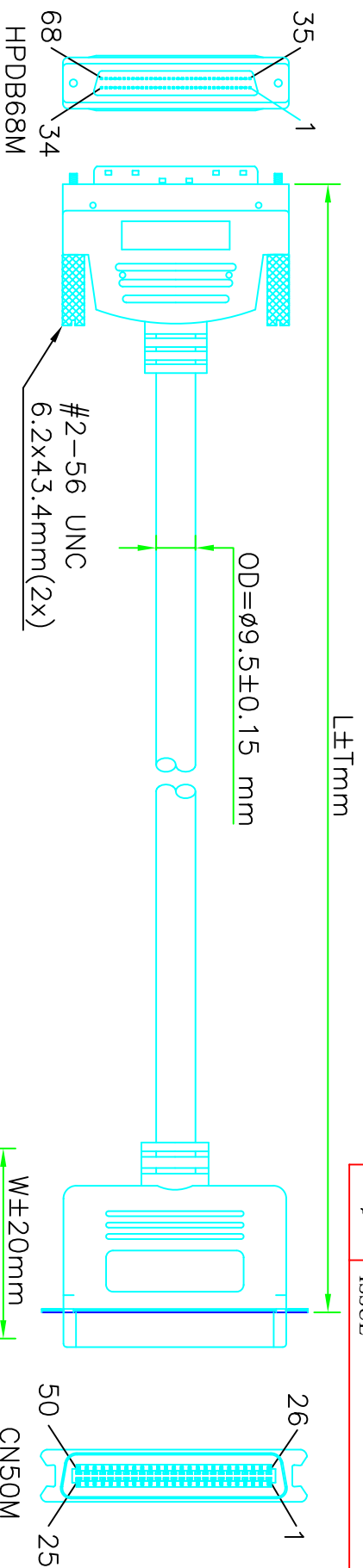


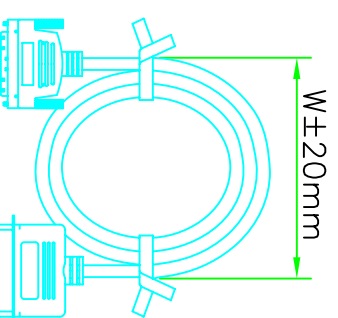
REV.	DESCRIPTION	DATE
Ø	ISSUE	2001.01.09



NOTE:

1. CONTINUITY TESTING:DC500V/10ms
- a. INSULATION RESISTANCE:20MΩ (MIN)
- b. CONTACT RESISTANCE:2Ω (MAX).
2. PIN OUT:SEE SHEET 2/2.
3. PACKING:SEE DETAIL "A".

DETAIL A



8	3021000431	METAL SCREW:6.2x43.4mm,#2-56UNC,BLACK ZINC PLATED.	2	PCS
7	6020000036	COPPER FOIL:36x130mm.	1	PC
6	6020000036	COPPER FOIL:36x140mm.	1	PC
5	4901010045	PVC:BLACK(SRI-001)45P.	76	g
4	4900040000	PE:FOR PREMOLD.	21	g
3	4900040000	CN50M:SOLDER TYPE,GOLD FLASH CONTACT,BLACK INSULATION.	1	PC
2	2060681005	HPDB68M:DC TYPE,5μ" GOLD PLATED CONTACT,BLACK INSULATION,FOR MOLDING TYPE.	1	SET
1	1289680011	CABLE:UL20276,30AWGx34PR(INSULATION:FO-PE,OD=Ø0.62±0.05mm),DIFFERENTIAL IMPEDANCE=132±10Ω ,AL-FOIL+BRAID, BLACK(SRI-001)PVC JACKET.(MADISON CABLE)	X	mm

P/N	L	T	X	W
C4010-3PX	914	25	930	160
C4010-6PX	1828	30	1845	180

DataStorageCables.com

NO.	PART NO.	DESCRIPTION	Q'TY
8	3021000431	METAL SCREW:6.2x43.4mm,#2-56UNC,BLACK ZINC PLATED.	2
7	6020000036	COPPER FOIL:36x130mm.	1
6	6020000036	COPPER FOIL:36x140mm.	1
5	4901010045	PVC:BLACK(SRI-001)45P.	76
4	4900040000	PE:FOR PREMOLD.	21
3	4900040000	CN50M:SOLDER TYPE,GOLD FLASH CONTACT,BLACK INSULATION.	1
2	2060681005	HPDB68M:DC TYPE,5μ" GOLD PLATED CONTACT,BLACK INSULATION,FOR MOLDING TYPE.	1
1	1289680011	CABLE:UL20276,30AWGx34PR(INSULATION:FO-PE,OD=Ø0.62±0.05mm),DIFFERENTIAL IMPEDANCE=132±10Ω ,AL-FOIL+BRAID, BLACK(SRI-001)PVC JACKET.(MADISON CABLE)	X

REV.	CLAS.	REV.	ANGLES	DWG. NO.	SHEET
Ø	CLAS.	REV.	ANGLES	C4010-xPBL	1 / 2

BILL OF MATERIAL